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FAIRCHILD

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SGS5N150UF

General Description

Fairchild's Insulated Gate Bipolar Transistor (IGBT) provides low conduction and switching losses. SGS5N150UF is designed for the Switching Power Supply applications.

Features

- High Speed Switching
- Low Saturation Voltage : $V_{CE(sat)} = 4.7 \text{ V} @ I_C = 5A$
- High Input Impedance

Application

Switching Power Supply - High Input Voltage Off-line Converter





Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Description		SGS5N150UF	Units
V _{CES}	Collector-Emitter Voltage		1500	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ T _C = 25°C	10	A
I _C	Collector Current	@ T _C = 100°C	5	A
I _{CM (1)}	Pulsed Collector Current		20	А
PD	Maximum Power Dissipation	@ T _C = 25°C	50	W
	Maximum Power Dissipation	@ T _C = 100°C	20	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

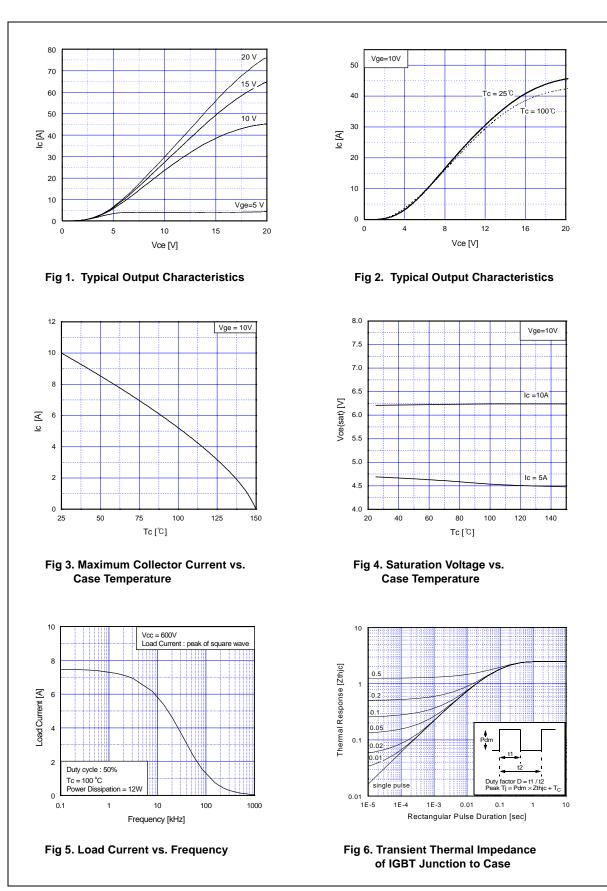
Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		2.5	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

IGBT

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$	1500			V
ICES	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			1.0	mA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
				1	L	1
Un Char V _{GE(th)}	racteristics	I _C = 5mA, V _{CE} = V _{GE}	2.0	3.0	4.0	V
	Collector to Emitter					
V _{CE(sat)}	Saturation Voltage	$I_{C} = 5A, V_{GE} = 10V$		4.7	5.5	V
Dynami	c Characteristics					
C _{ies}	Input Capacitance			780		pF
Soes	Output Capacitance	$V_{CE} = 10V_{,} V_{GE} = 0V_{,}$		130		pF
Cres	Reverse Transfer Capacitance	f = 1MHz		70		pF
	ng Characteristics			10	İ	1
t <mark>d(on)</mark>	Turn-On Delay Time	V _{CC} = 600 V		10		ns
r	Rise Time	$I_{\rm C} = 5A$		15		ns
d(off)	Turn-Off Delay Time	$R_{G} = 10\Omega$		30	50	ns
f	Fall Time Turn-On Switching Loss	V _{GE} = 10V		70	120	ns
on	<u> </u>	Inductive Load		190		uJ
off	Turn-Off Switching Loss	$T_{C} = 25^{\circ}C$		100 290	 580	uJ
ts	Total Switching Loss Total Gate Charge			290 30	45	uJ nC
ວ _g	Gate-Emitter Charge	$V_{CE} = 600 \text{ V}, \text{ I}_{C} = 5 \text{ A}$		3	5	nC
∡ _{ge} ⊋ _{gc}	Gate-Collector Charge	– V _{GE} = 10V		15	25	nC

SGS5N150UF

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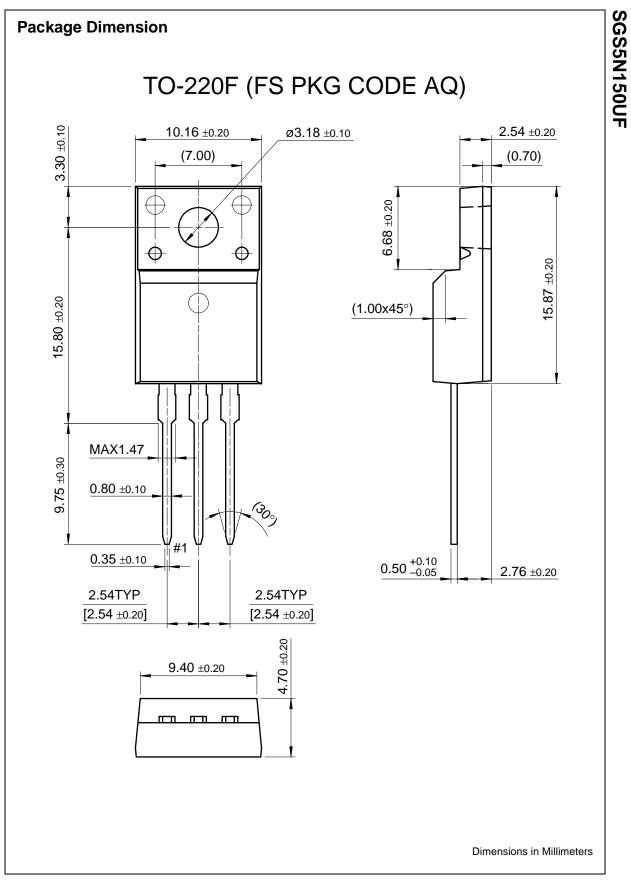
SGS5N150UF Rev. B

1200 Common Emitter $R_L = 120\Omega$, $V_{cc} = 600V$ 10 $T_c = 25^{\circ}C$ 1000 ≥8 Cies 800 Capacitance [pF] 600 400 200 Coes Cres 0 0 10 10 20 Gate Charge, Qg [nC] 1 0 30 Vce [V] Fig 7. Typical Capacitance vs. Fig 8. Typical Gate Charge Characteristic **Collector to Emitter Voltage** 1200 600 Vcc = 600V Vcc = 600V lc = 10A Rg = 10Ω Vge = 10V Ic = 5AEsw 1000 500 800 400 400 [m] Abuendo [m] 300 Energy [uJ] Eon lc = 5A 600 400 Ic = 3A200 Eoff 200 100 10 15 20 25 20 40 60 80 100 0 5 30 Tc[℃] Rg [Ω] Fig 9. Typical Switching Loss vs. Fig 10. Typical Switching Loss vs. **Gate Resistance Case Temperature** 1.2 Vcc = 600V Esw Rg = 10Ω Tc = 100°C 1.0 10 0.8 Energy [mJ] lc [A] Eon 0.6 Eoff 0.4 Safe Operating Area Vge = 20V, Tc = 100 °C 0.2 1 4 6 8 10 10 100 1000 1 lc [A] Vce [V] Fig 11. Typical Switching Loss vs. Fig 12. Turn-Off SOA **Collector Current**

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The Power Franc	hise™	OPTOPLANAR™	SMART START™	

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